# SILIERRA

LEADING FOUNDRY SOLUTIONS IN A **CONNECTED WORLD** 

#### CUSTOMIZED **FOUNDRY SERVICES**

For customer-specific proprietary devices

Full support of process transfers from R&D lab to SilTerra

Process development for customers from conceptual stage to product level

Flexibility for new tools and metrology investments based on business case

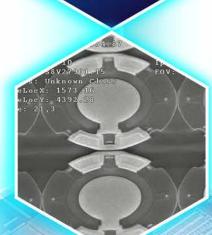
Robust process matching for optimized manufacturability, yield and reliability

Volume manufacturing



MEMS/ SENSORS/ LIFE SCIENCES **BUSINESS** 

MODEL



#### **MEMS DEVICES & INTEGRATED SOLUTIONS**

Truly monolithic solutions based on SilTerra's patented device architecture

> For targeted market / customer driven applications

> > Availability of standard silicon validated cells

Development of collaborative partnerships for downstream processes (testing, packaging, dicing)

> Customization of MEMS prototype for specific applications

Volume manufacturing

### **APPLICATIONS**



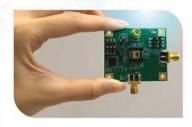
- Biophotonics DNA sequencing chips
- Microfluidics for point-of-care (POC) devices



- Micromirrors for autonomous cars, data projectors
- Motion sensors for wearables
- Sensors (acoustic, infrared, electrostatic)

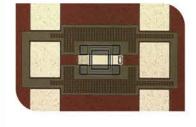


 pMUT for fingerprint sensing, medical imaging, industrial sensors, biosensors, gesture control



SAW resonators for timing devices





**BAW** resonators for RF transceivers, RF filters, biosensors

## FAB CAPABILITIES

- 8-inch CMOS wafer foundry. Design-in capacity: 46,000 WSPM
- Equipment capable down to 90nm (Cu/Al backend interconnect capabilities, ArF Scanner)
- Unique tools: Cu/Al backend interconnect capabilities · ArF Scanner · Deep Reactive Ion Etching (DRIE) · Physical Vapor Deposition (AIN, ScAIN, Mo) · XeF2 Si Release · **Electrostatic Temporary Bonder**
- Automotive-qualified production site IATF 16949:2016
- ISO 9001:2015, ISO 14001:2015, OHSAS 18001:2007 and QC 080000-certified

